

INTERFACE CIRCUIT – RELAY AND LAMP – DRIVER

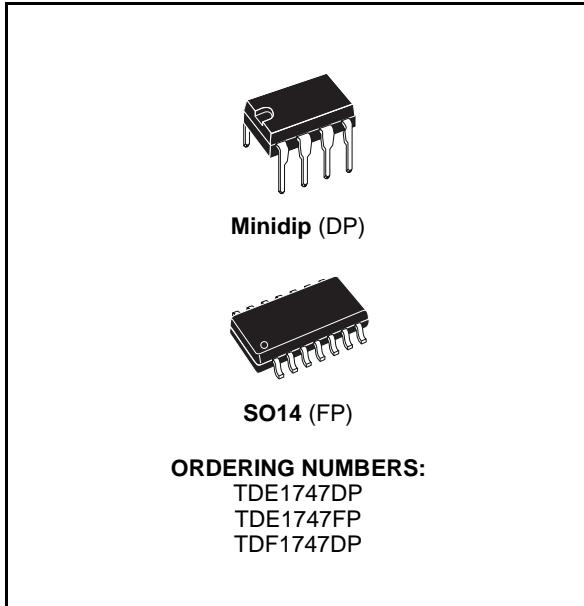
- OPEN GROUND PROTECTION
- HIGH OUTPUT CURRENT
- ADJUSTABLE SHORT-CIRCUIT PROTECTION TO GROUND
- THERMAL PROTECTION WITH HYSTERESIS TO AVOID THE INTERMEDIATE OUTPUT LEVELS
- LARGE SUPPLY VOLTAGE RANGE : + 10 V TO + 45 V
- SHORT-CIRCUIT PROTECTION TO Vcc

DESCRIPTION

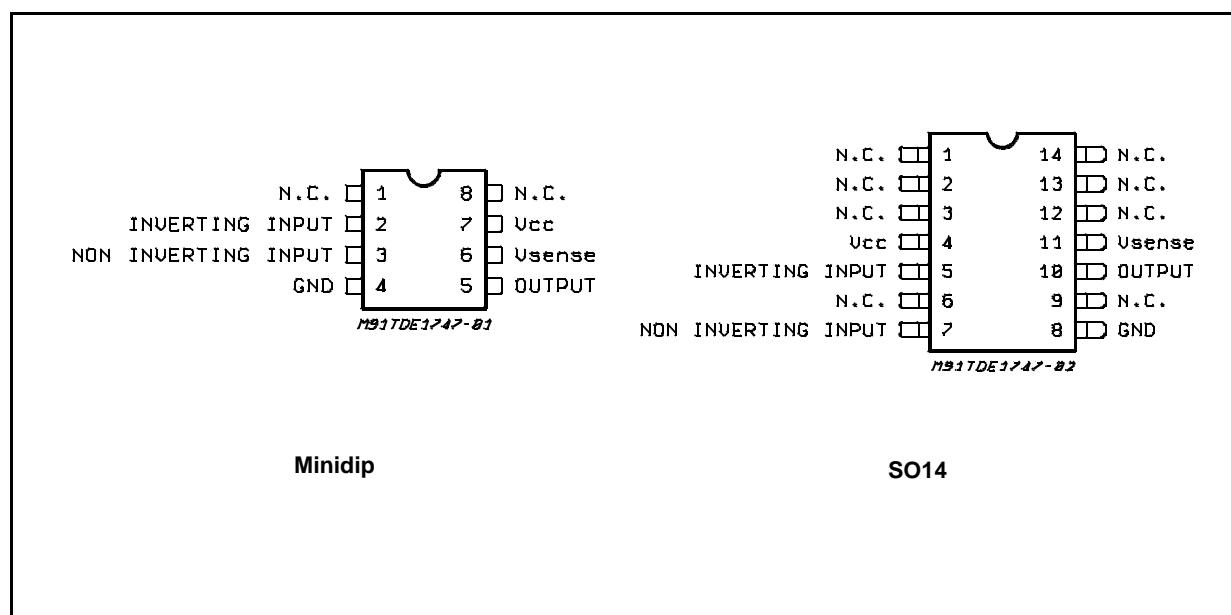
The TDE/TDF1747 is a monolithic comparator designed for high current and high voltage applications, specifically to drive lamps, relays, stepping motors.

These device is essentially blow-out proof. Current limiting is available to limit the peak output current to safe values, the adjustment only requires one external resistor. In addition, thermal shut down is provided to keep the I.C. from overheating. If internals dissipation becomes too great, the driver will shut down to prevent excessive heating. TDE1747 has an open ground protection. The output is also protected from short-circuits with the positive power supply.

PIN CONNECTIONS (Top view)



The device operates over a wide range of supply voltages from standard ± 15 V operational amplifier supplies down to the single + 12 V or + 24 used for industrial electronic systems.



TDE1747 - TDF1747

ABSOLUTE MAXIMUM RATINGS

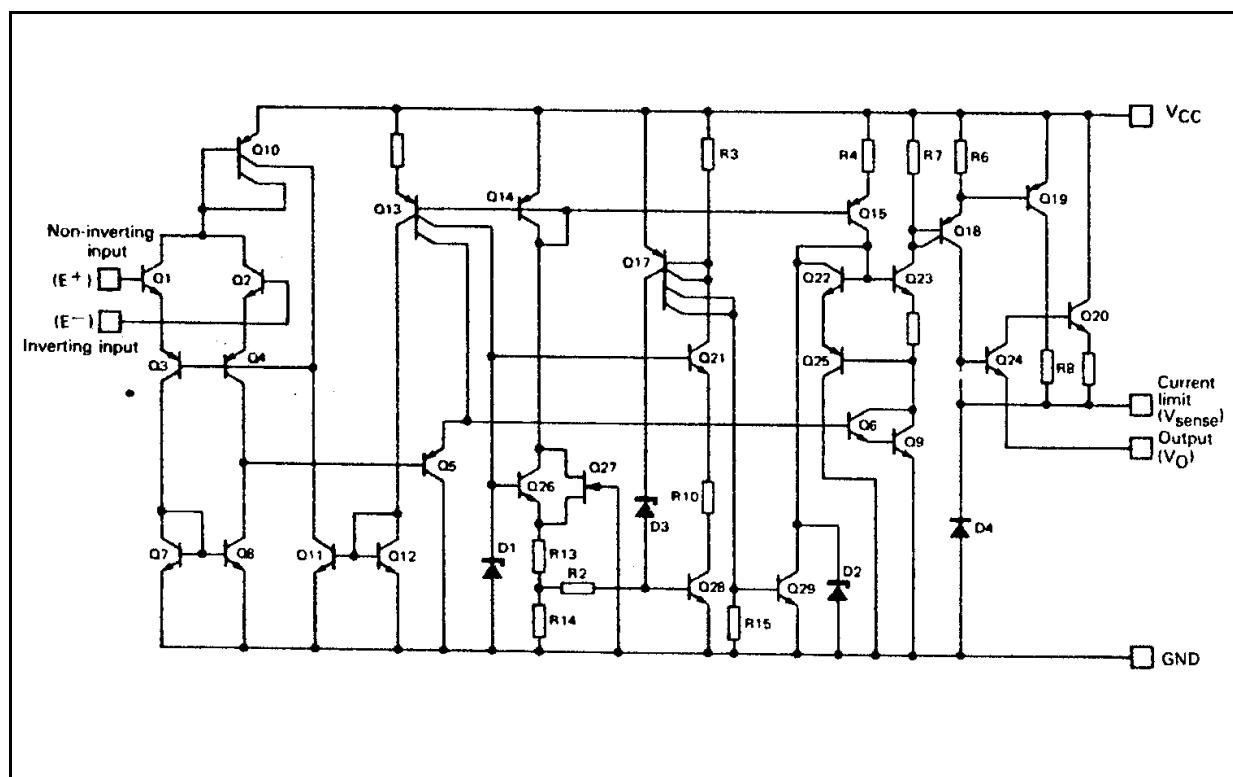
| Symbol | Parameter | Value | Unit |
|------------|---|--------------------|--------------------|
| V_{CC} | Supply Voltage | 50 * | V |
| V_{ID} | Differential Input Voltage | 50 | V |
| V_I | Input Voltage | 50 | V |
| I_O | Output Current | 1 | A |
| P_{tot} | Power Dissipation ($T_{amb} = + 25 \text{ }^{\circ}\text{C}$) | Internally Limited | W |
| T_{stg} | Storage Temperature Range | – 65 to + 150 | $^{\circ}\text{C}$ |
| T_{oper} | Operating Ambient Temperature Range | | |
| | TDE1747 | – 25 to + 85 | $^{\circ}\text{C}$ |
| | TDF1747 | – 40 to + 85 | $^{\circ}\text{C}$ |

(*) 60V, t à 10ms

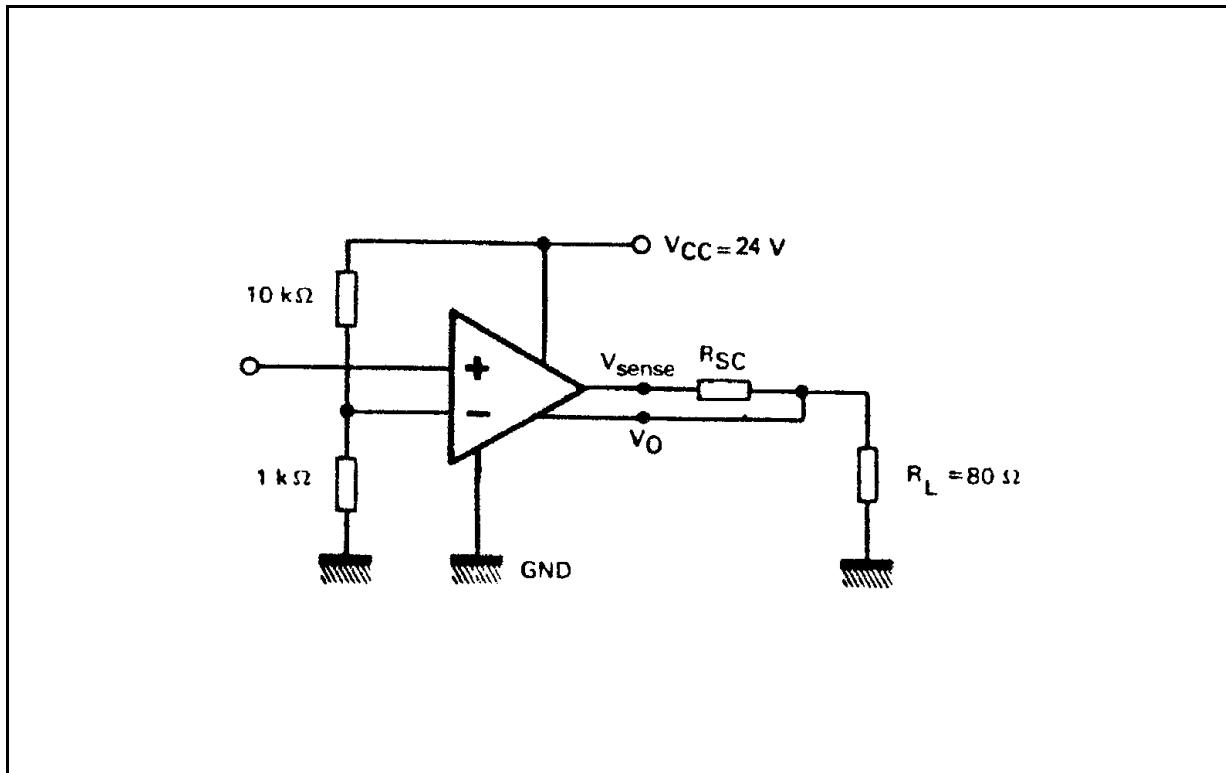
THERMAL CHARACTERISTICS

| Symbol | Parameter | Value | Unit | |
|---------------|---|-------|---------|------|
| $R_{th(j-c)}$ | Maximum Junction-case Thermal Resistance | 50 | °C/W | |
| $R_{th(j-a)}$ | Maximum Junction-ambient Thermal Resistance | 120 | °C/W | |
| R_{th} | Junction-ceramic Substrate (case glued to substrate) | SO14 | 90 | °C/W |
| R_{th} | Junction-ceramic Substrate (case glued to substrate, substrate temperature maintained constant) SO14 | | 65 °C/W | |

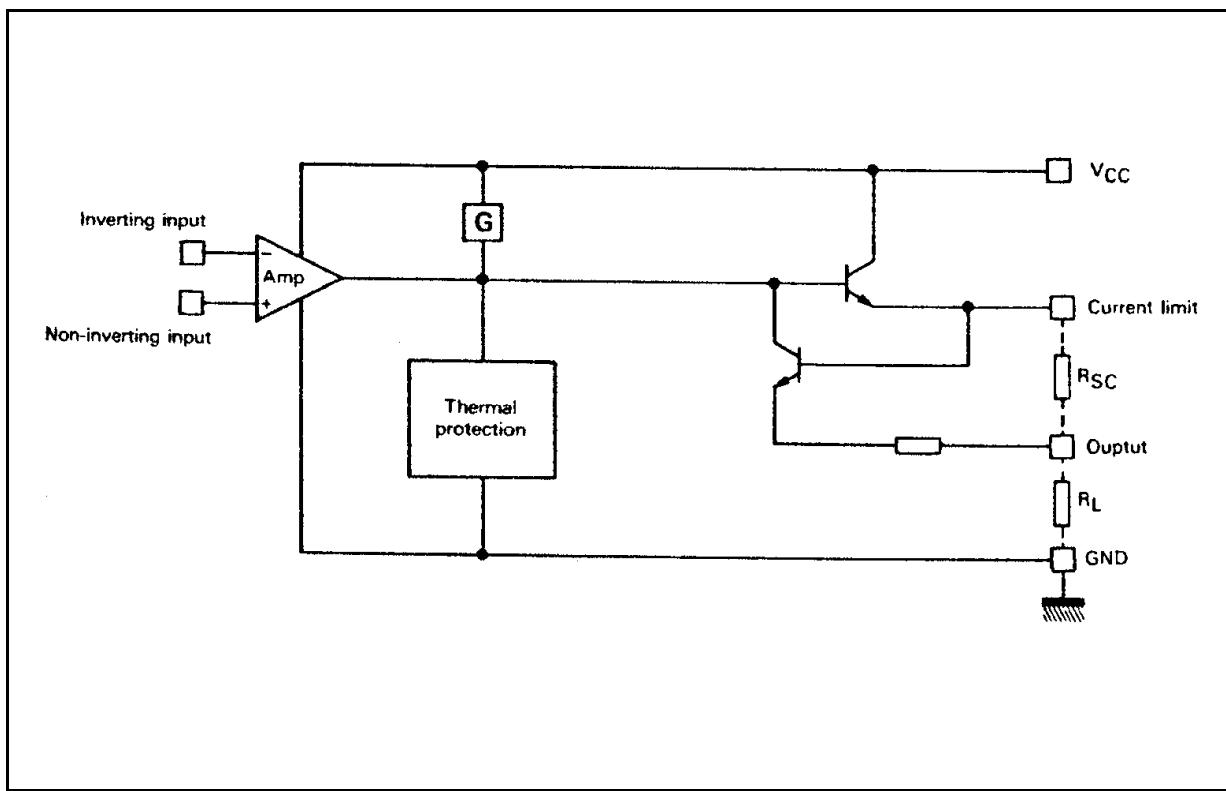
SCHEMATIC DIAGRAM



TEST CIRCUIT



SIMPLIFIED CIRCUIT



TDE1747 - TDF1747

ELECTRICAL CHARACTERISTICS $T_j = -25$ to $+85^\circ\text{C}$, $V_{CC} = 8$ to 45 V , unless otherwise specified (note 1).

| Symbol | Parameter | Min. | Typ. | Max. | Unit |
|--------------|--|---------|--------------|------------|---------------|
| V_{IO} | Input Offset Voltage - (note 2) | — | 2 | 50 | mV |
| I_{IB} | Input Bias Current | — | 0.1 | 1.5 | mA |
| I_{CC} | Supply Current ($V_{CC} = +24\text{ V}$, $I_O = 0$) High Level Low Level | — — | 4 2 | 6 4 | mA mA |
| $V_{I(max)}$ | Common-mode Input Voltage Range | 2 | — | $V_{CC}-2$ | V |
| I_{SC} | Short-circuit Current Limit ($T_{amb} = +25^\circ\text{C}$, $V_{CC} = +24$) $R_{SC} = 1.5\ \Omega$ $R_{SC} = \infty$ | TDE1747 | | 480 35 | — 50 |
| $V_{CC}-V_O$ | Output Saturation Voltage (output high) ($R_{SC} = 0$, $V_I+ - V_I- \geq 50\text{ mV}$) $I_O = 300\text{ mA}$, $T_j = +25^\circ\text{C}$ $T_j = +150^\circ\text{C}$ | — — | 1.15 1.05 | 1.4 1.3 | V V |
| I_{OL} | Low Level Output Current ($V_O = 0$, $V_{CC} = +24\text{ V}$) $T_j = +25^\circ\text{C}$ | — | 0.01 | 10 | μA |

Notes :

1) For operating at high temperature, the TDE/TDF1747, must be derated based on a $+150^\circ\text{C}$ maximum junction temperature and a junction-ambient thermal resistance of $120^\circ\text{C}/\text{W}$ for Minidip and $100^\circ\text{C}/\text{W}$ for the SO14.

2) The offset voltage given is the maximum value of input voltage required to drive the output voltage within 2 V of the ground or the supply voltage.

Figure 1: Available Output Current vs. Limiting Resistor

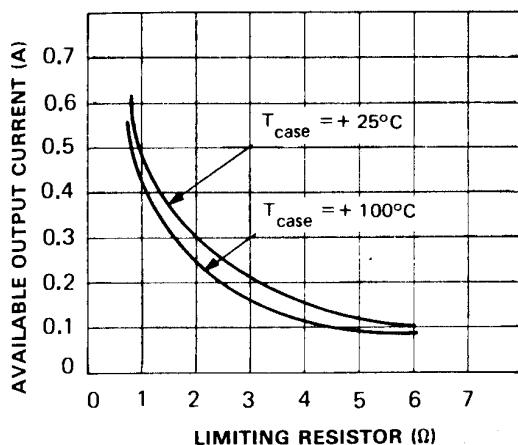


Figure 2: Peak Short-circuit Output Current vs. Limiting Resistor

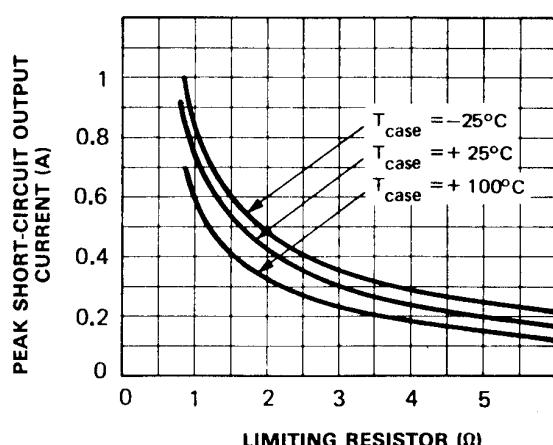


Figure 3: Short-circuit Current vs. Case Temperature

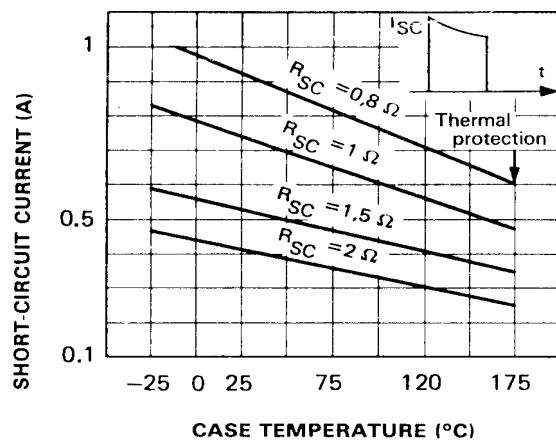


Figure 5: Output Current vs. Output Saturation Voltage

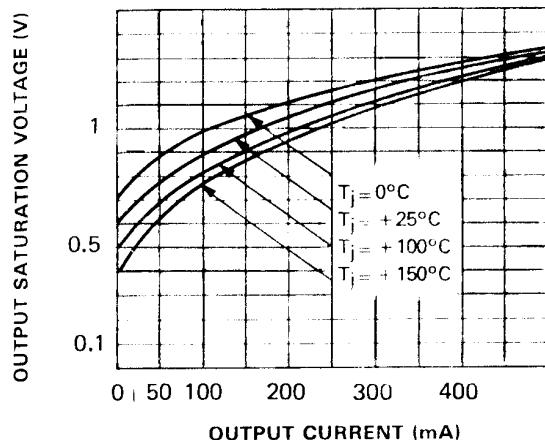


Figure 7: Supply Current vs. Junction Temperature

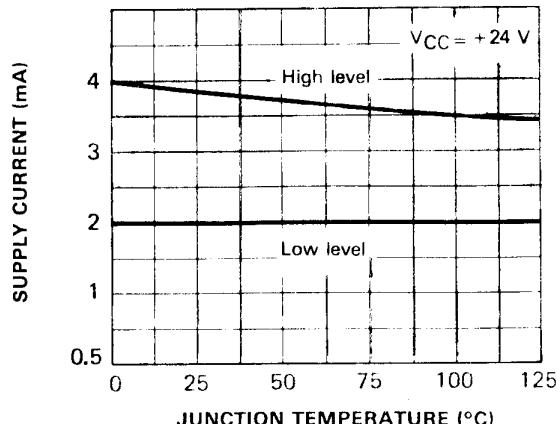


Figure 4: Minimum Limiting Resistor Value vs. Supply Voltage

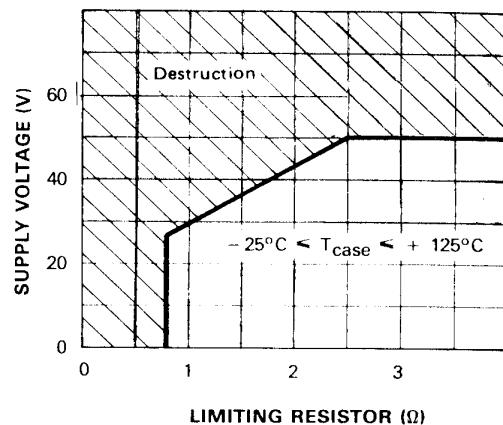


Figure 6: Supply Current vs. Supply Voltage

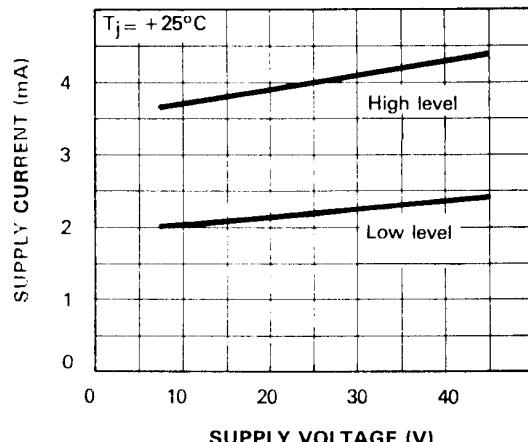
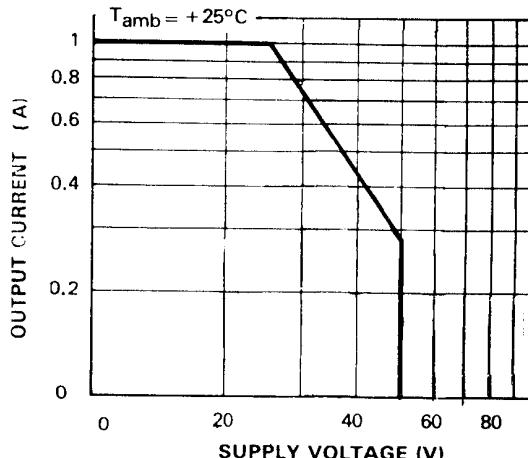
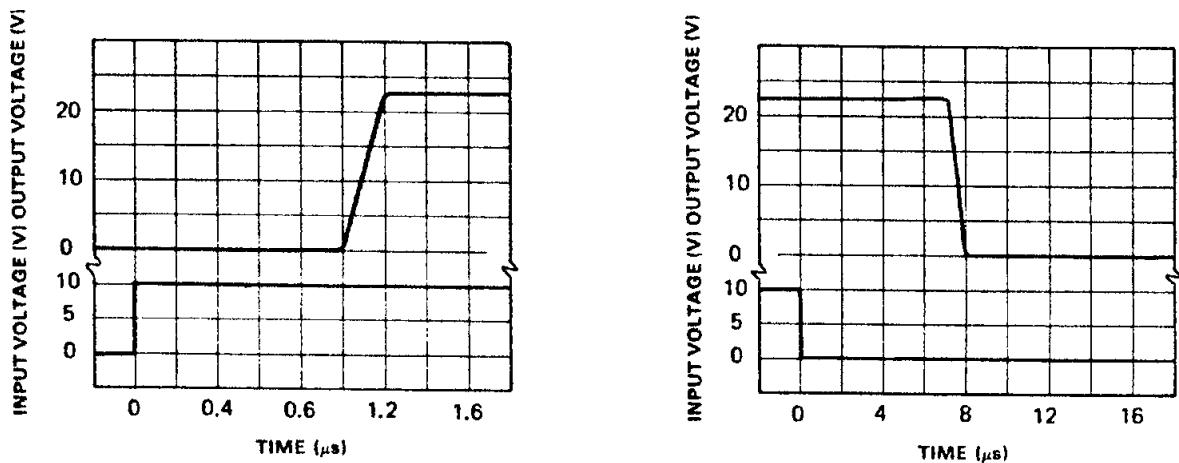


Figure 8: Safe Operating Area (non repetitive surge)



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Figure 9: Response Time



TYPICAL APPLICATIONS

Figure 10: Base Circuit

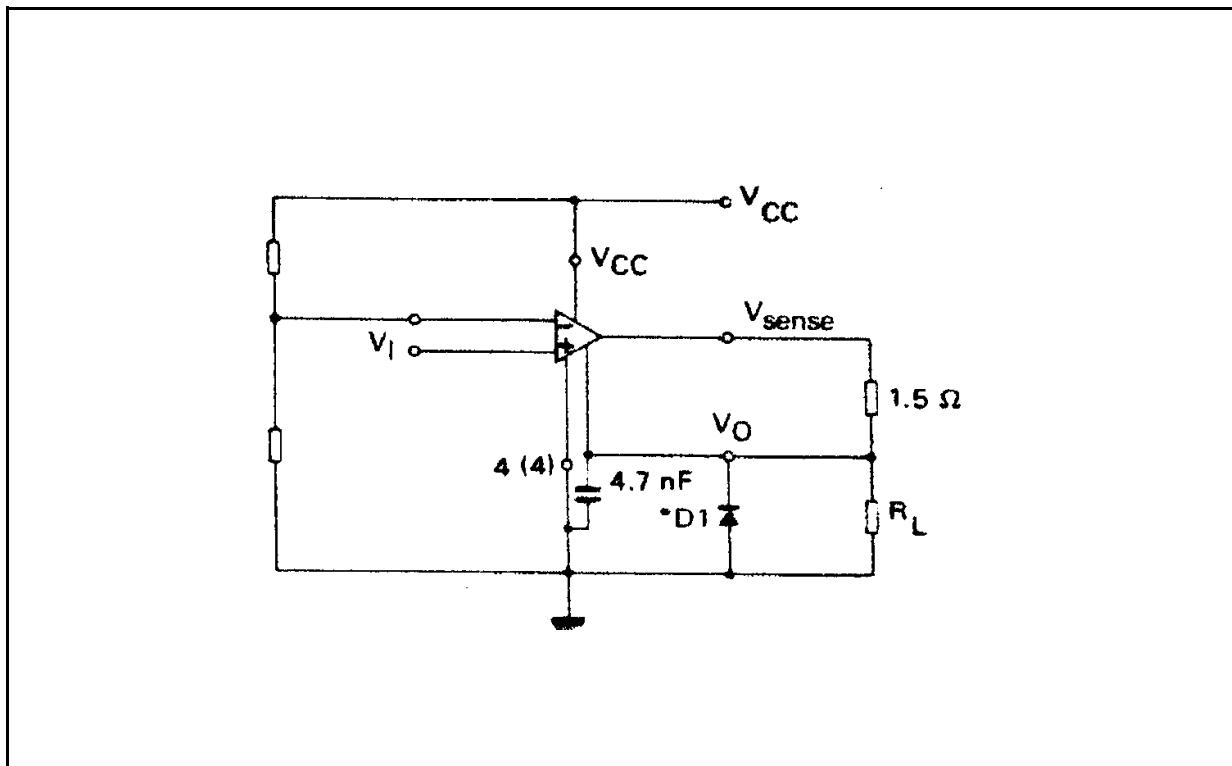
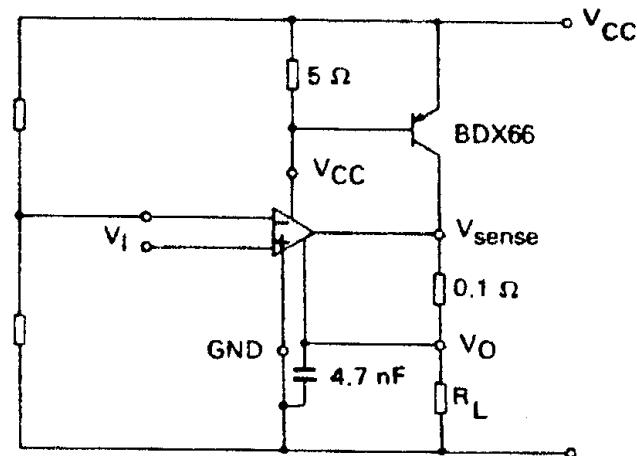
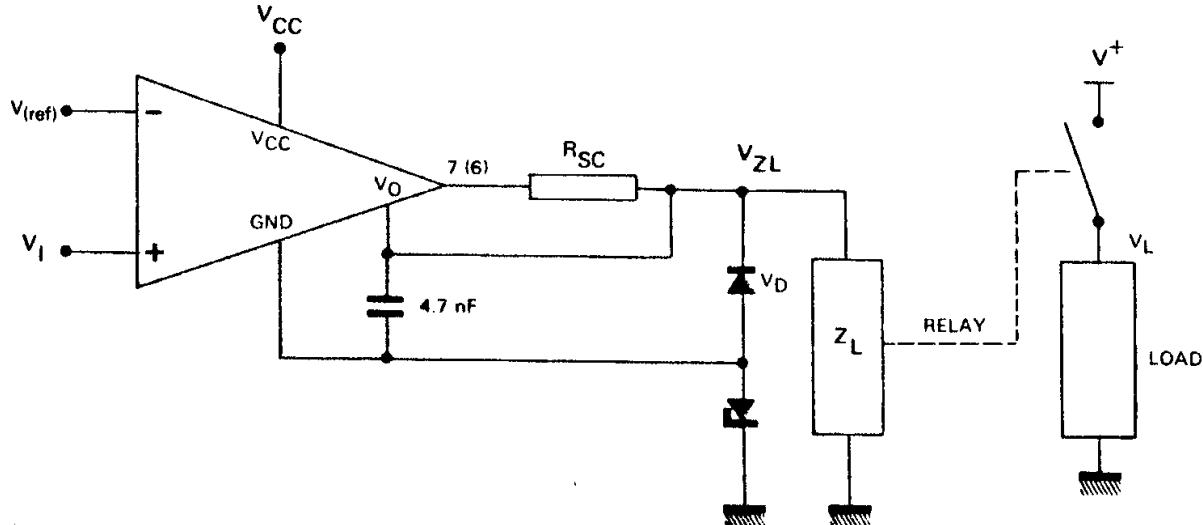
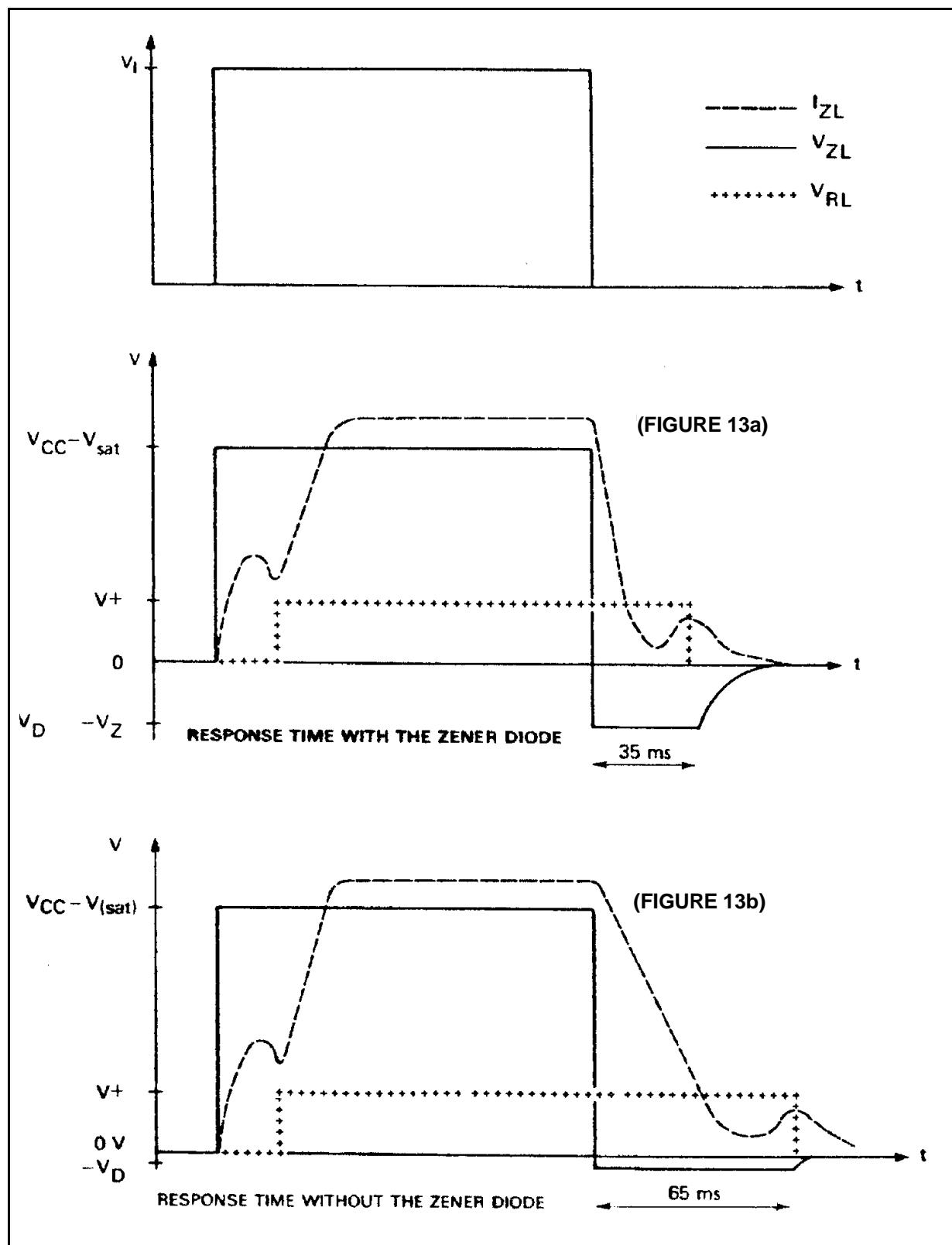


Figure 11: Output Current Extension (5A)**Figure 12:** Driving Low Impedance Relays ($I_O = 300\text{mA}$)

The device in the above application operates at: $V_{CC} = +45\text{V}$, $I_O = 300\text{mA}$ with a heatsink such that $R_{th(j-a)} \leq 80^\circ\text{C}/\text{W}$. The device supports an output voltage of $V_{CC} = V_Z$ during the current cut off time, which is decreased by the zener diode. This voltage must be \leq to the maximum supply voltage.

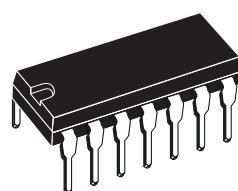
TDE1747 - TDF1747

Figure 13: Waveforms

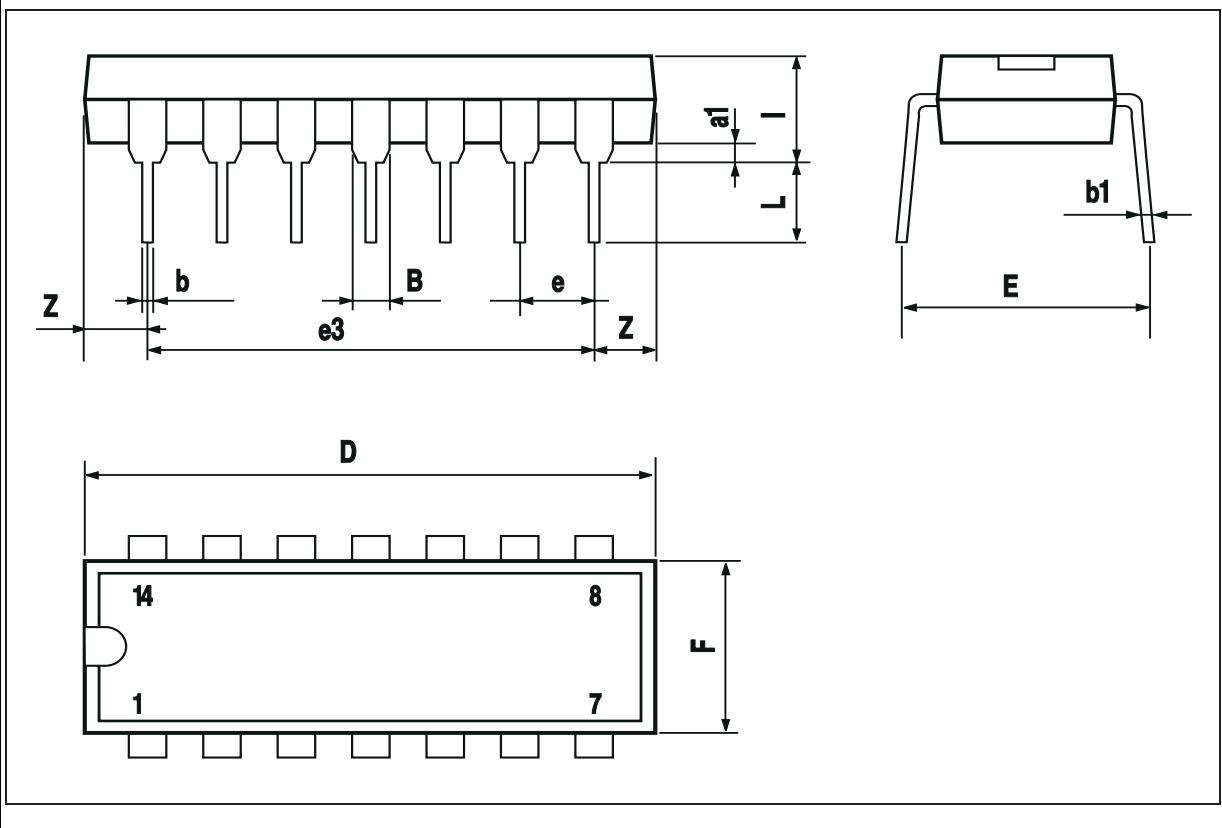


| DIM. | mm | | | inch | | |
|------|------|-------|------|-------|-------|-------|
| | MIN. | TYP. | MAX. | MIN. | TYP. | MAX. |
| a1 | 0.51 | | | 0.020 | | |
| B | 1.39 | | 1.65 | 0.055 | | 0.065 |
| b | | 0.5 | | | 0.020 | |
| b1 | | 0.25 | | | 0.010 | |
| D | | | 20 | | | 0.787 |
| E | | 8.5 | | | 0.335 | |
| e | | 2.54 | | | 0.100 | |
| e3 | | 15.24 | | | 0.600 | |
| F | | | 7.1 | | | 0.280 |
| I | | | 5.1 | | | 0.201 |
| L | | 3.3 | | | 0.130 | |
| Z | 1.27 | | 2.54 | 0.050 | | 0.100 |

OUTLINE AND MECHANICAL DATA

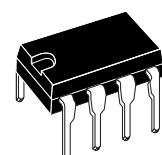


DIP14

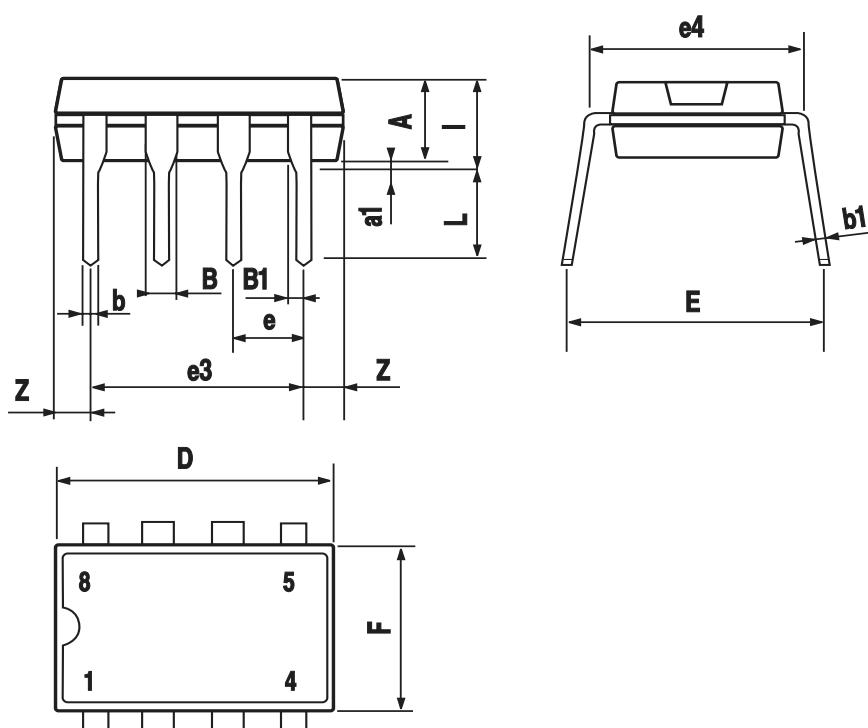


| DIM. | mm | | | inch | | |
|------|-------|-------|-------|-------|-------|-------|
| | MIN. | _TYP. | MAX. | MIN. | _TYP. | MAX. |
| A | | 3.32 | | | 0.131 | |
| a1 | 0.51 | | | 0.020 | | |
| B | 1.15 | | 1.65 | 0.045 | | 0.065 |
| b | 0.356 | | 0.55 | 0.014 | | 0.022 |
| b1 | 0.204 | | 0.304 | 0.008 | | 0.012 |
| D | | | 10.92 | | | 0.430 |
| E | 7.95 | | 9.75 | 0.313 | | 0.384 |
| e | | 2.54 | | | 0.100 | |
| e3 | | 7.62 | | | 0.300 | |
| e4 | | 7.62 | | | 0.300 | |
| F | | | 6.6 | | | 0.260 |
| I | | | 5.08 | | | 0.200 |
| L | 3.18 | | 3.81 | 0.125 | | 0.150 |
| Z | | | 1.52 | | | 0.060 |

OUTLINE AND MECHANICAL DATA



Minidip



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